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## APPROVAL SHEET

MODEL NO.:	nSMD 005	

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:	
HEAD OFFICE:	
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	Tel: 86-752-3562001
	Fax:86-752-3558696
	E-mail:service@atpptc.com

SEA & LAND ELECTRONIC CORP.



## nSMD 005

#### Features

- Surface Mount Devices
- Lead free device
   Size 3.2\*1.6 mm/0.12\*0.06 inch
- Surface Mount packaging
- for automated assembly

#### Applications

Almost anywhere there is a low voltage power supply, up to 60V and a load to be protected, including: Computer mother board, Modem. USB hub PDAs & Charger, Analog & digital line card

Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea&Land Alliance)

#### Performance Specification

	Model	Marking	V <sub>max</sub>	I <sub>max</sub>	I <sub>hold</sub>	I <sub>trip</sub>	Pd	Maxiı Time T		Resi	stance	Agency J	Approval
	Woder	warking	(Vdc)	(A)	@25°C (A)	@25°C (A)	Max. (W)	Current (A)	Time (Sec)	Ri <sub>min</sub> (Ω)	R1max (Ω)	UL	τυν
	nSMD005	αZ	60.0	100	0.05	0.15	0.4	0.25	1.50	3.600	50.000		
lhold	Ihold = Hold Current. Maximum current device will not trip in 25°C still air.												
Itrip	trip = Trip Current. Minimum current at which the device will always trip in 25°C still air.												
Vmax	Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).												
Imax	Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).												
Pd	Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.												
Rimin	Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.												
R1 <sub>max</sub>	R1 <sub>max</sub> = Maximum device resistance is measured one hour post reflow.												
CAUT	CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.												

#### **Environmental Specifications**

Test	Conditions	Resistance change					
Passive aging	+85°C, 1000 hrs.	±5% typical					
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical					
Thermal shock	+85°C to -40°C, 20 times	±33% typical					
Resistance to solvent	MIL-STD-202, Method 215	No change					
Vibration	MIL-STD-202,Method 201	No change					
Ambient operating conditions : - 40 °C to 85 °C							
Maximum surface temperature of the de	evice in the tripped state is 125 °C						

Agency Approvals :

UL pending

Regulation/Standard:



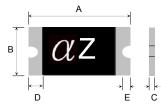
2002/95/EC EN14582

#### Ihold Versus Temperature

Madal	Maximum ambient operating temperature (T <sub>map</sub> ) vs. hold current (I <sub>hold</sub> )								
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
nSMD005	0.074	0.066	0.058	0.05	0.0425	0.038	0.035	0.03	0.0275

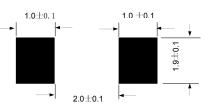
SMD 005						4	Alpha-Top (Sea	Land Alliand
nstruction And Di		nm) A		B		•	D	Ξ
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
nSMD005	3.00	3.50	1.50	1.80	0.60	1.10	0.15	0.10

#### **Dimensions & Marking**



 $\alpha$  = Trademark Z = Part identification

#### **Recommended Pad Layout (mm)**



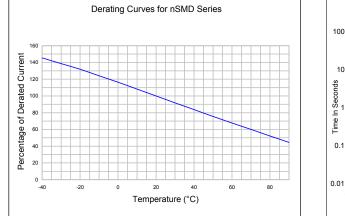
#### **Termination Pad Characteristics**

Terminal pad materials : Terminal pad solderability : Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

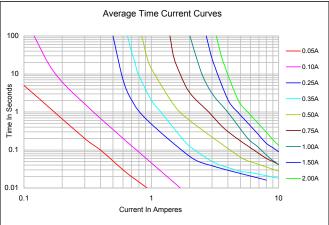
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

#### **Thermal Derating Curve**



## Typical Time-To-Trip At 25°C



## WARNING:

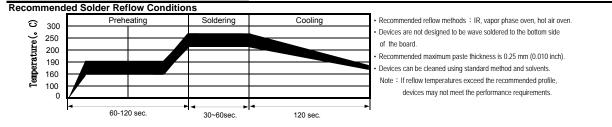
Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

• DPTC are intended for protection against occasional over current or were magnetain possible conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
• Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space. • Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods. • Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

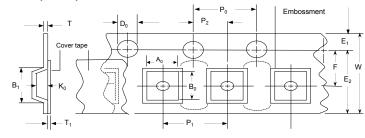
## nSMD 005



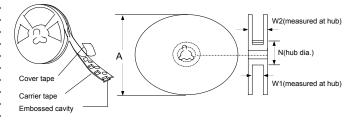
#### Tape And Reel Specifications (mm)

$\begin{tabular}{ c c c c c c c } \hline W & 8.15 \pm 0.3 \\ \hline P0 & 4.0 \pm 0.10 \\ \hline P1 & 4.0 \pm 0.10 \\ \hline P1 & 4.0 \pm 0.10 \\ \hline P2 & 2.0 \pm 0.05 \\ \hline A0 & 1.95 \pm 0.10 \\ \hline B0 & 3.45 \pm 0.10 \\ \hline B1max. & 4.35 \\ \hline D0 & 1.5 \pm 0.1, 0 \\ \hline F & 3.5 \pm 0.05 \\ \hline E1 & 1.75 \pm 0.1, 0 \\ \hline F & 3.5 \pm 0.05 \\ \hline E1 & 1.75 \pm 0.10 \\ \hline E2min. & 6.25 \\ \hline Tmax. & 0.6 \\ \hline Tmax. & 0.1 \\ \hline K0 & 1.04 \pm 0.1 \\ \hline Leader min. & 390 \\ \hline Trailer min. & 160 \\ \hline Reel Dimensions & \\ \hline A max. & 178 \\ \hline N min. & 60 \\ \hline W1 & 9 \pm 0.5 \\ \hline W2 & 12.6 \pm 0.5 \\ \hline \end{tabular}$	Governing Specifications	EIA 481-1
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	W	8.15 ± 0.3
$\begin{array}{c cccc} P2 & 2.0 \pm 0.05 \\ \hline A0 & 1.95 \pm 0.10 \\ \hline B0 & 3.45 \pm 0.10 \\ \hline B1max. & 4.35 \\ \hline D0 & 1.5 \pm 0.1, -0 \\ \hline F & 3.5 \pm 0.05 \\ \hline E1 & 1.75 \pm 0.10 \\ \hline E2min. & 6.25 \\ \hline Tmax. & 0.6 \\ \hline T1max. & 0.1 \\ \hline K0 & 1.04 \pm 0.1 \\ \hline Leader min. & 390 \\ \hline Trailer min. & 1600 \\ \hline Reel Dimensions \\ \hline A max. & 178 \\ \hline N min. & 60 \\ \hline W1 & 9 \pm 0.5 \\ \end{array}$	P0	4.0 ± 0.10
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	P1	4.0 ± 0.10
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	P2	2.0 ± 0.05
B1max.         4.35           D0         1.5 + 0.1, -0           F         3.5 ± 0.05           E1         1.75 ± 0.10           E2min.         6.25           Tmax.         0.6           T1max.         0.1           K0         1.04 ± 0.1           Leader min.         390           Trailer min.         160           Reel Dimensions         178           N min.         60           W1         9 ± 0.5	A0	1.95 ± 0.10
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	B0	3.45 ± 0.10
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	B1max.	4.35
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		1.5 + 0.1, -0
E2min.         6.25           Tmax.         0.6           T1max.         0.1           K0         1.04 ± 0.1           Leader min.         390           Trailer min.         160           Reel Dimensions         4           A max.         178           N min.         60           W1         9 ± 0.5	F	$3.5 \pm 0.05$
Tmax.         0.6           T1max.         0.1           K0         1.04 ± 0.1           Leader min.         390           Trailer min.         160           Reel Dimensions         178           N min.         60           W1         9± 0.5	E1	1.75 ± 0.10
T1max.         0.1           K0         1.04 ± 0.1           Leader min.         390           Trailer min.         160           Reel Dimensions         178           N min.         60           W1         9 ± 0.5	E2min.	6.25
K0         1.04 ± 0.1           Leader min.         390           Trailer min.         160           Reel Dimensions         7           A max.         178           N min.         60           W1         9 ± 0.5	Tmax.	0.6
Leader min.         390           Trailer min.         160           Reel Dimensions         178           A max.         178           N min.         60           W1         9±0.5	T1max.	0.1
Trailer min.         160           Reel Dimensions	KO	1.04 ± 0.1
A max.         178           N min.         60           W1         9±0.5	Leader min.	390
A max.         178           N min.         60           W1         9±0.5	Trailer min.	160
N min.         60           W1         9±0.5	Reel Dimensions	
W1 9±0.5	A max.	178
	N min.	60
W2 12.6 ± 0.5	W1	9 ± 0.5
	W2	12.6 ± 0.5

### EIA Tape Component Dimensions



#### **EIA Reel Dimensions**



Storage And Handling • Storage conditions : 40°C max, 70% R.H.

· Devices may not meet specified performance if storage conditions are exceeded.

Order Information	Packaging		
nSMD	005	Tape & Reel Quantity	
Product name	Hold		
Size 3216 mm / 1206 inch	Current	3,500 pcs/reel	
SMD : surface mount device	0.05A		

Tape & reel packaging per EIA481-1

Labeling Information

